( ) Preliminary Specifications
(V) Final Specifications

Module	**11.6”(11.58”) HD 16:9 Color TFT-LCD with LED Backlight design**
Model Name	**B116XAK01.0 (H/W:3A)**
Note ( )	***oTP Lite Display***

Customer	**Date**
Checked & Approved by	**Date**

Approved by	**Date**
Marcus Yen	2019/02/11
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Note: This Specification is subject to change without notice.

AU Optronics corporation

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Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2018/10/18	All	First Edition for Customer		
1.0 2019/02/11	All		Final Spec	

1. Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.
2) Be sure to turn off power supply when inserting or disconnecting from input connector.
3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
7) Do not open nor modify the Module Assembly.
8) Do not press the reflector sheet at the back of the module to any directions.
9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
10) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
11) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
12) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.

2. General Description

B116XAK01.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP (Embedded DisplayPort) interface compatible.

B116XAK01.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 ℃ condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	294.09 (11.58W")			
Active Area	[mm]	256.125(H) x 144(V)			
Pixels H x V		1366x3(RGB) x 768			
Pixel Pitch	[mm]	0.1875 x 0.1875			
Pixel Format		R.G.B. Vertical Stripe			
Display Mode		Normally Black (AHVA)			
White Luminance (I_{LED}=25mA) (Note: ILED is LED current)	[cd/m^2]	250 typ. (5 points average) 212 min. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		800 typ			
Response Time	[ms]	27 typ / 35 Max			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	2.8 max (Include Logic and Blu power) Mosaic			
Weight	[Grams]	200 g max (Total Solution)[1]			
Physical Size	[mm]		Min.	Typ.	Max.
		Length	277.5	278.0	278.5
		Width	167.52	168.02	168.52

[1] Total solution max weight includes touch sensor and FPCA.

		Thickness	-	-	3.0 (Panel Side) 3.2 (PCBA Side)
Total solution [Note: Touch module]	[mm]		Min.	Typ.	Max.
		Length	277.5	278.0	278.5
		Width	167.52	168.02	168.52
		Thickness	-	-	3.0 (Panel Side) 3.2 (PCBA Side)
Electrical Interface		1 Lane eDP 1.2			
Glass Thickness	[mm]	0.4			
Surface Treatment		Glare			
Support Color		262K colors (RGB 6-bit)			
Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60			
RoHS Compliance		RoHS Compliance			

2.2 General Touch Specification

Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive	
Panel Size	11.6''	
Outline Dimension	278.0 * 168.02 typ	mm
Total Thickness	3.2 max (Panel only)	mm
Total Weight	200 max (Panel only)	g
TP View Area	NA	mm
TP Active Area	258.55 X 146.4 typ	mm
Interface	I2C	
Report Rate	Follow Chrome	Hz
Multi-Touch Point	10 points	
Input method	Finger	
Touch panel sensor IC	Elan (eKTH5012AY)	
Channel	56 X 32	
Distance between 2 point	Follow Chrome	mm
Surface hardness	3 (Note 1)	H
Surface treatment	Glare	
TP F/W version	56.23	
Support OS	Chrome	

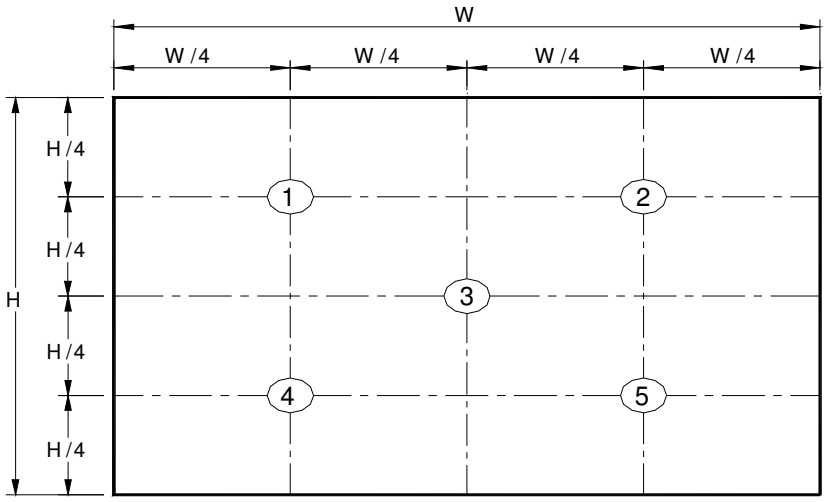
Note1: Polarizer Test condition: Working speed: 50cycle/min, Moves distance: 100mm/sec (Exceptions to the rubber tip of the diameter is 6mm). Measuring Process: The Load force and the friction material are fixed on 25mm diameter cylinder tooling. Polarizer pasted on bare glass and the start to test. Inspect on the 500/1000/1500/2000 cycles.

2.3 Optical Characteristics

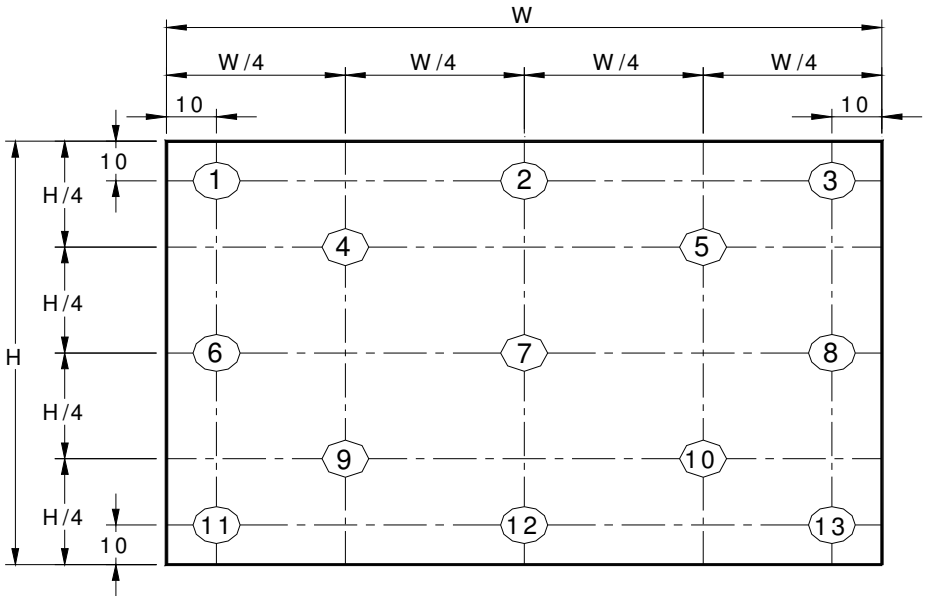
The optical characteristics are measured under stable conditions at 25℃ (Room Temperature) :

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance ILED=25mA (Base Panel Only)			5 points average	212	250	-	cd/m2	1, 4, 5.
Viewing Angle		θR θL	Horizontal (Right) CR = 10 (Left)	80 80	85 85	- -	degree	4, 9
		ψH ψL	Vertical (Upper) CR = 10 (Lower)	80 80	85 85	- -		
Luminance Uniformity		δ5P	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ13P	13 Points	-	-	1.6		2, 3, 4
Contrast Ratio		CR		600	800	-		4, 6
Cross talk		%				4		4, 7
Response Time		TRT	Rising + Falling	-	27	35		
Color / Chromaticity Coodinates	Red	Rx	CIE 1931	0.560	0.590	0.620	-	4
		Ry		0.320	0.350	0.380		
	Green	Gx		0.302	0.332	0.362	-	
		Gy		0.544	0.574	0.604		
	Blue	Bx		0.126	0.156	0.186	-	
		By		0.081	0.111	0.141		
	White	Wx		0.283	0.313	0.343	-	
		Wy		0.299	0.329	0.359		
NTSC		%		-	50	-		

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



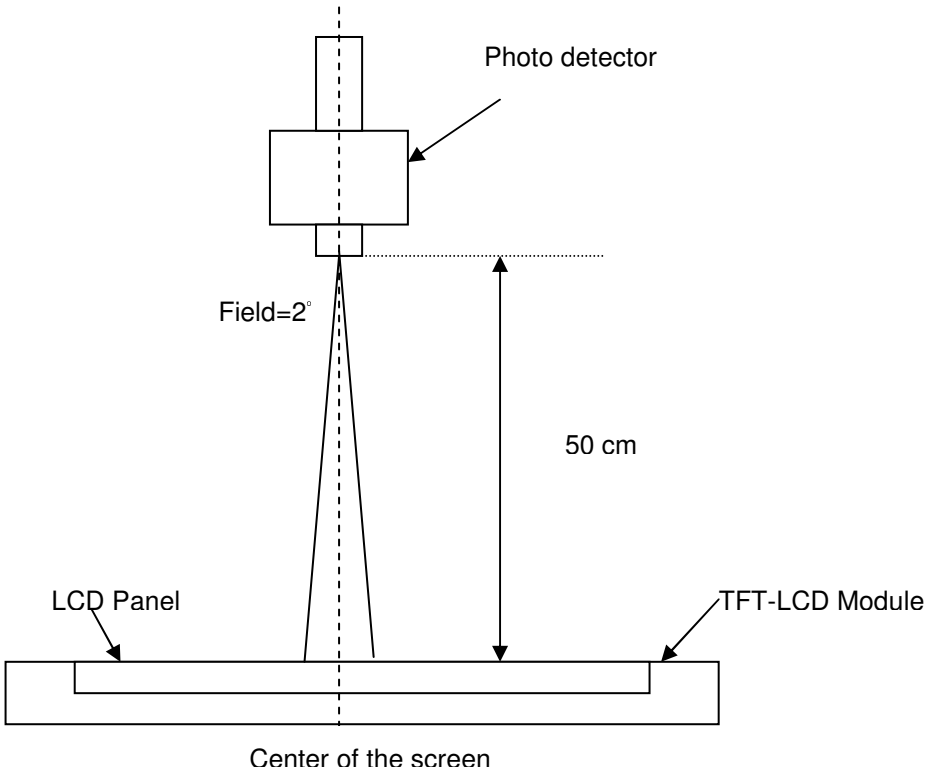
Note 3: The luminance uniformity of 5 or13 points is defined by dividing the maximum luminance values by the minimum test point luminance

$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5： Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points，Y_L = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5

L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6： Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the “White” state}}{\text{Brightness on the “Black” state}}$$

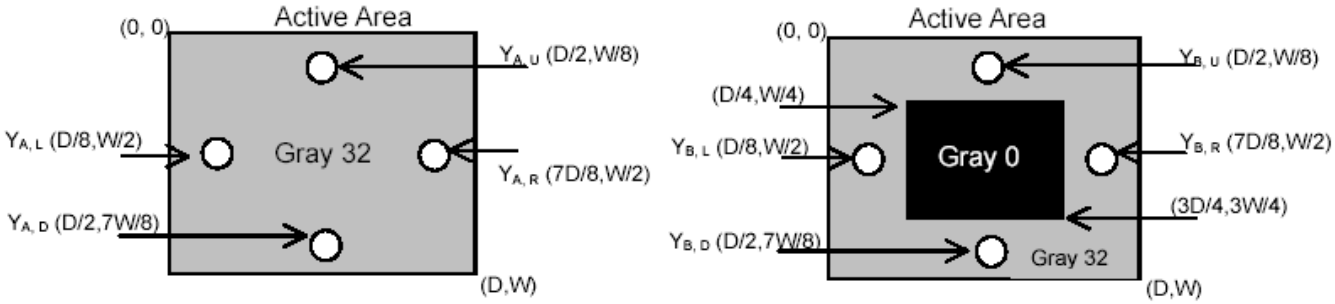
Note 7： Definition of Cross Talk (CT)

$CT = | Y_B – Y_A | / Y_A \times 100\ (\%)$

Where

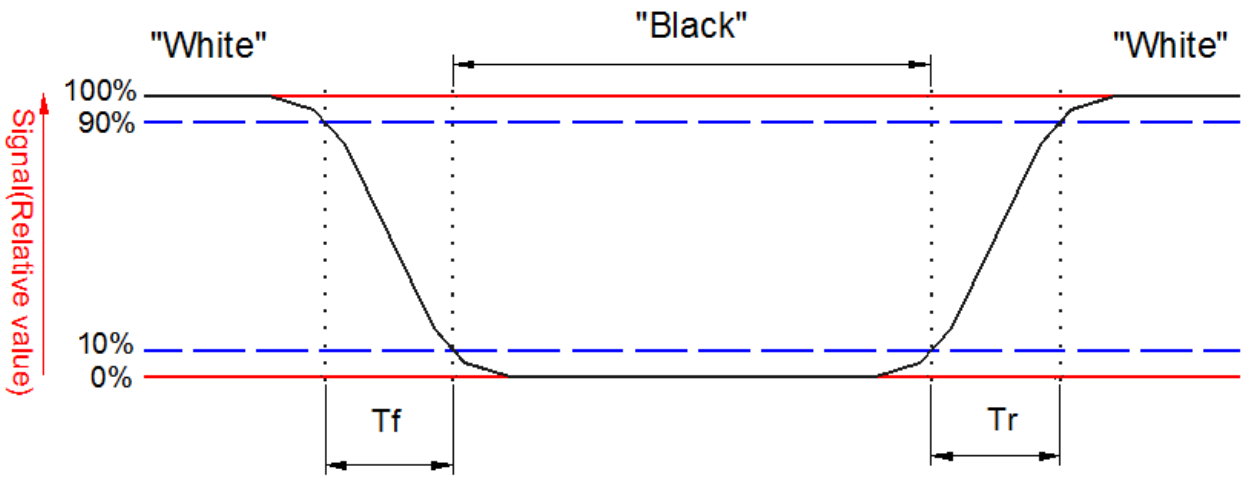
Y_A = Luminance of measured location without gray level 0 pattern (cd/m^2)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m^2)



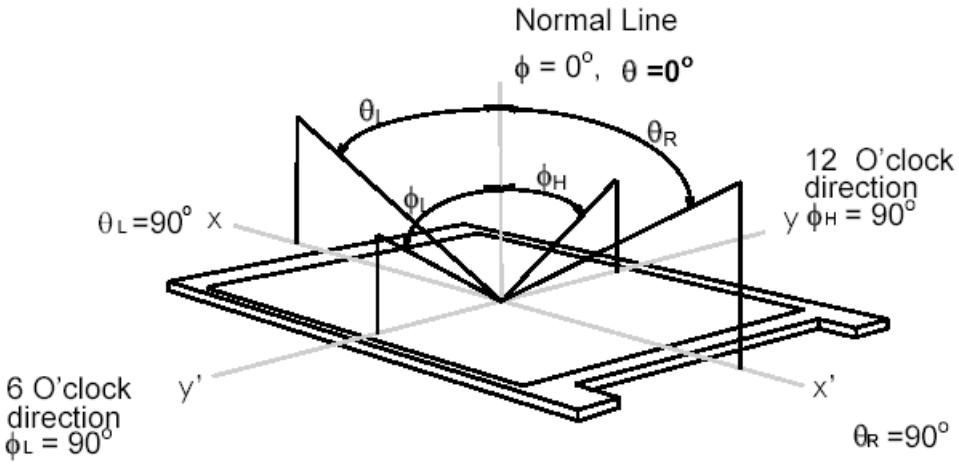
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from “Black” to “White” (rising time) and from “White” to “Black” (falling time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



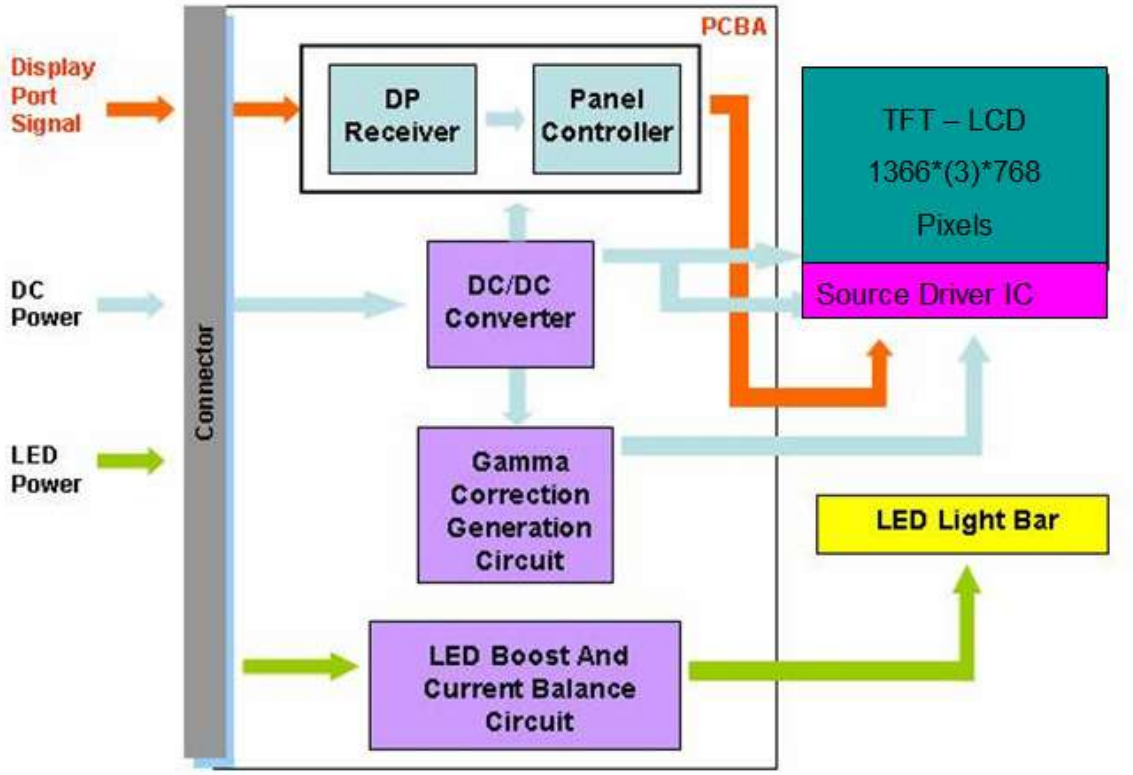
Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≧10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



3. Functional Block Diagram

The following diagram shows the functional block of the 11.6 inches wide Color TFT/LCD 40 Pin



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

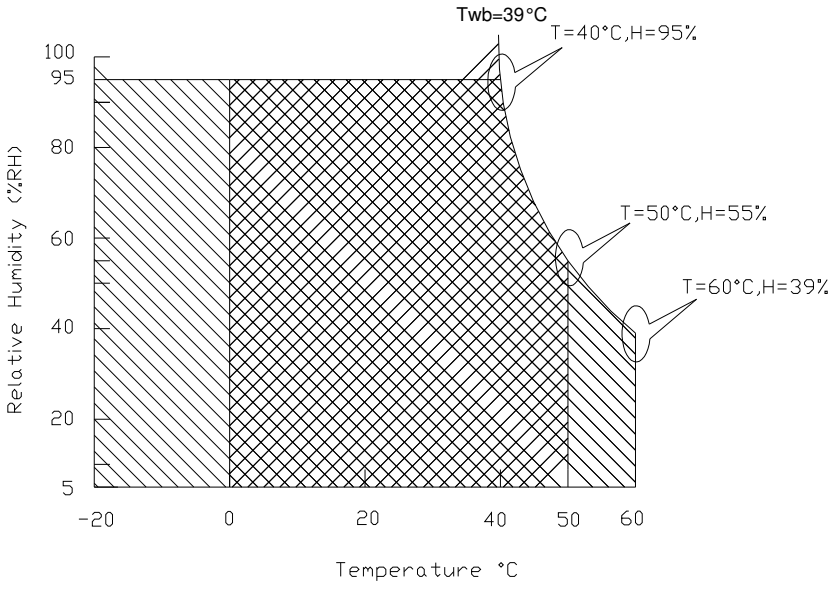
4.2 Absolute Ratings of Touch Sensor Module

Item	Symbol	Min	Max	Unit	Conditions
Touch Sensor Module Power Voltage	VTSP	-0.5	4	[Volt]	
Touch Sensor Module Reset Signal	RST	-0.5	4	[Volt]	
Touch Sensor Module enable Signal	TP_EN	-0.5	4	[Volt]	

4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25℃)
Note 2: Permanent damage to the device may occur if exceed maximum values
Note 3: LED specification refer to section 5.2
Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).
Note 5: The packing material of system forbid to involve ammonium component
Note 6: The reliability test conditions of system do not exceed the verified conditions of TFT module
Note 7: Be sure the panel test condition do not exceed the component limitation of TFT module(TN Liquid crystal , for example)



5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

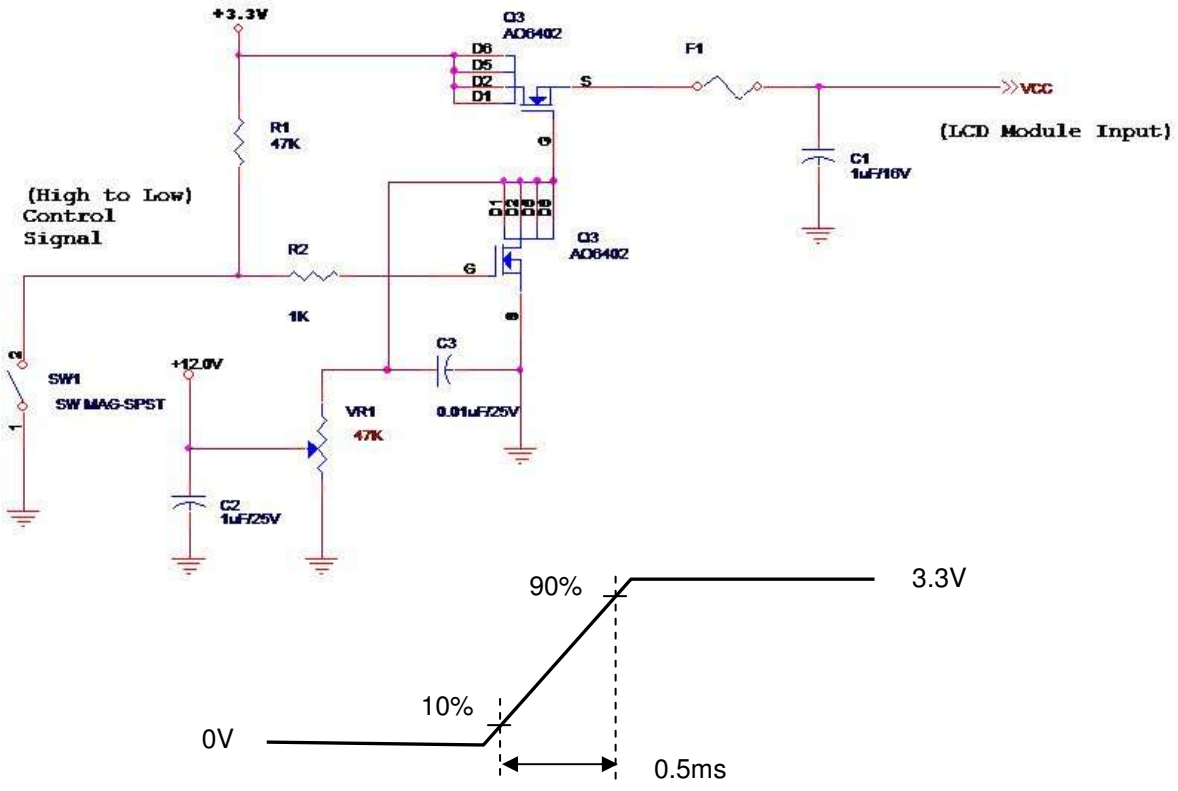
The power specification are measured under 25℃ and frame frenquency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	0.9	1.12	[Watt]	Note 1
IDD	IDD Current(RMS)	-	-	373	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: PDD(Typ)@Mosaic pattern Maximum Power, PDD(Max)@R/G/B pattern Maximum Power

IDD(Max) = PDD(Max) / VDD(Min)

Note 2：Measure Condition

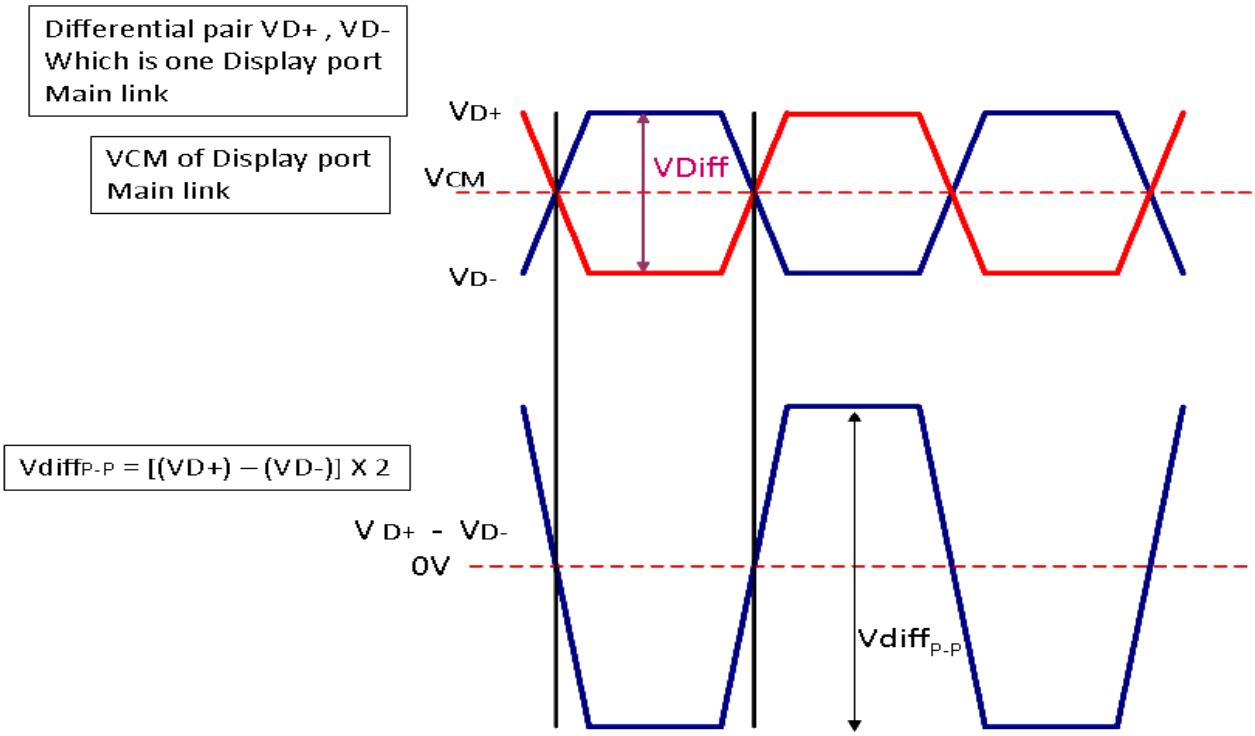


Vin rising time

5.1.2 Signal Electrical Characteristics

Signal electrical characteristics are as follows;

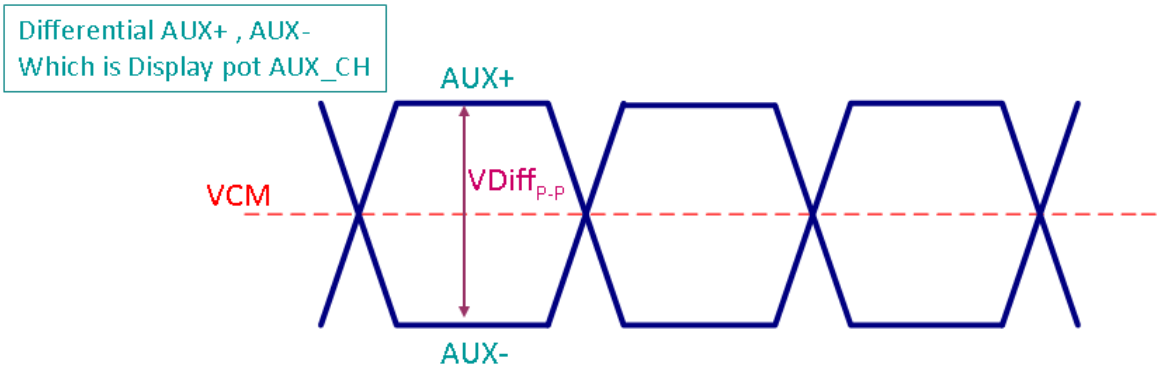
Display Port main link signal:



Display port main link					
		Min	Typ	Max	unit
VCM	RX input DC Common Mode Voltage		0		V
$VDiff_{P-P}$	Peak-to-peak Voltage at a receiving Device	150		1320	mV

Follow as VESA display port standard V1.4

Display Port AUX_CH signal:



Display port AUX_CH					
		Min	Typ	Max	unit
VCM	AUX DC Common Mode Voltage		0		V
$VDiff_{P-P}$	AUX Peak-to-peak Voltage at a receiving Device	270		800	mV

Follow as VESA display port standard V1.3

Display Port V_{HPD} signal:

Display port V_{HPD}					
		Min	Typ	Max	unit
V_{HPD}	HPD Voltage	2.25		3.6	V

Follow as VESA display port standard V1.3

5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	1.9	[Watt]	**(Ta=25℃), Note 1**
LED Life-Time	N/A	15,000	-	-	Hour	**(Ta=25℃), Note 2 I_F=25 mA**

Note 1: Calculator value for reference P_{LED} = V_F (Normal Distribution) * I_F (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED (Note 1)	6.0	12.0	21.0	[Volt]	Define as Connector Interface (Ta=25℃)
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level		-	-	0.5	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.5	[Volt]	
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	5	--	100	%	

Note 1 : Recommend system pull up/down resistor no bigger than 10kohm

.

5.3 Touch Sensor Module

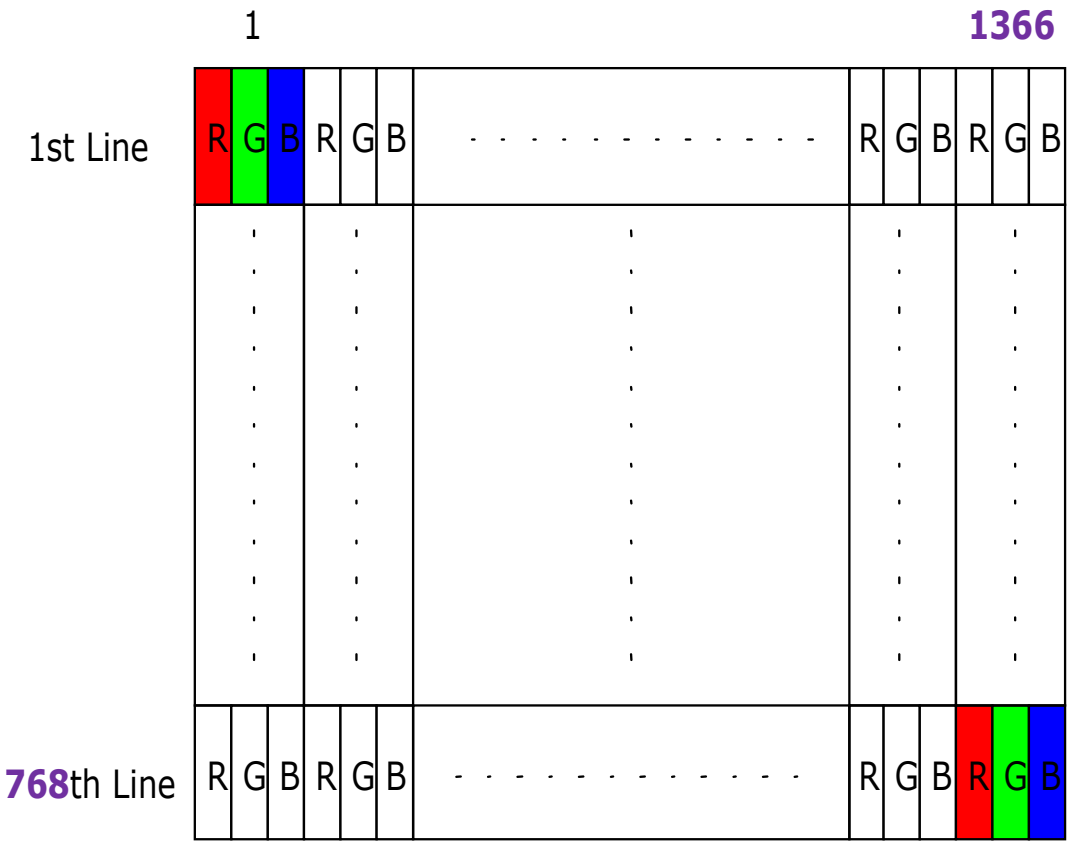
5.3.1 Power Specification

Items	Symbol		Specifications			Unit	Notes
			Min.	Typ.	Max.		
Touch sensor module Power Supply	VTSP		3.15	3.3	3.6	V	
Touch sensor module Power Consumption	PTP	Active	-	-	350		
		Idle	-	-	90		
		Sleep	-	-	0.5		
Touch Sensor Module Power ripple	VTSPrp		-	-	100	mV	
Input Voltage	RST, TP_EN	VIH	2.64		3.3	V	
		VIL	0		0.66	V	

6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.



6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

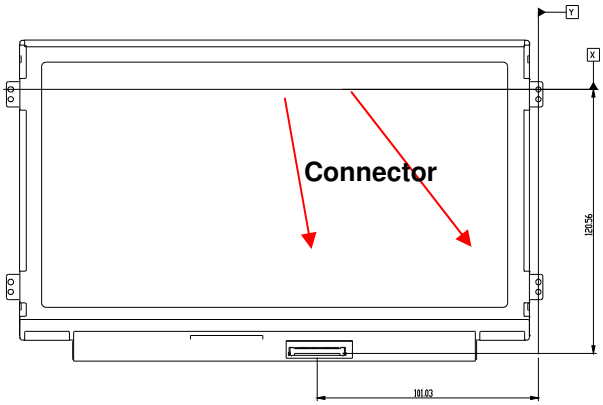
These connectors are capable of accommodating the following signals and will be following components.

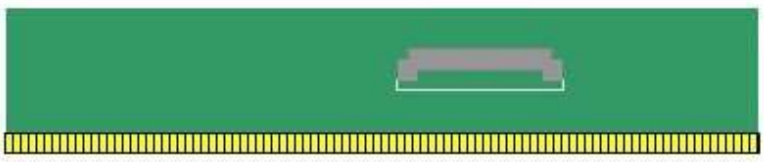
Connector Name / Designation	For Signal Connector
Manufacturer	JAE or Compatible
Type / Part Number	JAE HD1S040HA1 or compatible
Mating Housing/Part Number	JAE HD1P040MA1 or compatible

6.2.2 Pin Assignment (with Touch Sensor Pin Assignment)

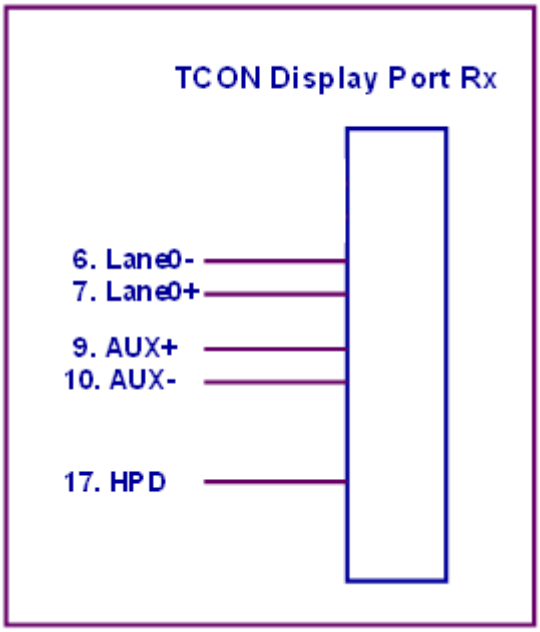
PIN NO	Symbol	Function
1	NC	No Connect (Reserved for DCR)
2	H_GND	High Speed Ground
3	NC	No Connect
4	NC	No Connect
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test or NC	LCD Panel Self Test Enable (Optional)
15	LCD_GND	LCD logic and driver ground
16	LCD_GND	LCD logic and driver ground
17	HPD	HPD signal pin
18	BL_GND	Backlight ground
19	BL_GND	Backlight ground
20	BL_GND	Backlight ground
21	BL_GND	Backlight ground
22	BL_Enable	Backlight On / Off
23	BL_PWM_DIM	System PWM signal Input
24	NC	No connect (Reverse for TEST only)
25	NC	No connect (Reverse for TEST only)
26	BL_PWR	Backlight power
27	BL_PWR	Backlight power
28	BL_PWR	Backlight power
29	BL_PWR	Backlight power
30	NC	No Connect (Reserved for CM)
31	TP_D-	USB Data- for Touch (NC for I2C input)
32	TP_D+	USB Data+ for Touch(NC for I2C input)
33	GND	Ground
34	VTSP	Touch panel power supply

35	VTSP	Touch panel power supply
36	NC/TP_EN	Reserve for Touch function enable (Low_Disable & High_Enable)
37	TP_CLK	I2C Clock for Touch (NC for USB input)
38	TP_Data	I2C Data for Touch (NC for USB input)
39	**TP_I2C INT**	Touch panel I2C-INT(NC for USB input)
40	TP_RST	Touch panel IC reset, Low active





Note1: Start from right side.
Note2: Input signals shall be low or High-impedance state when VDD is off.
Internal circuit of **eDP inputs** are as following.



6.3 Interface Timing

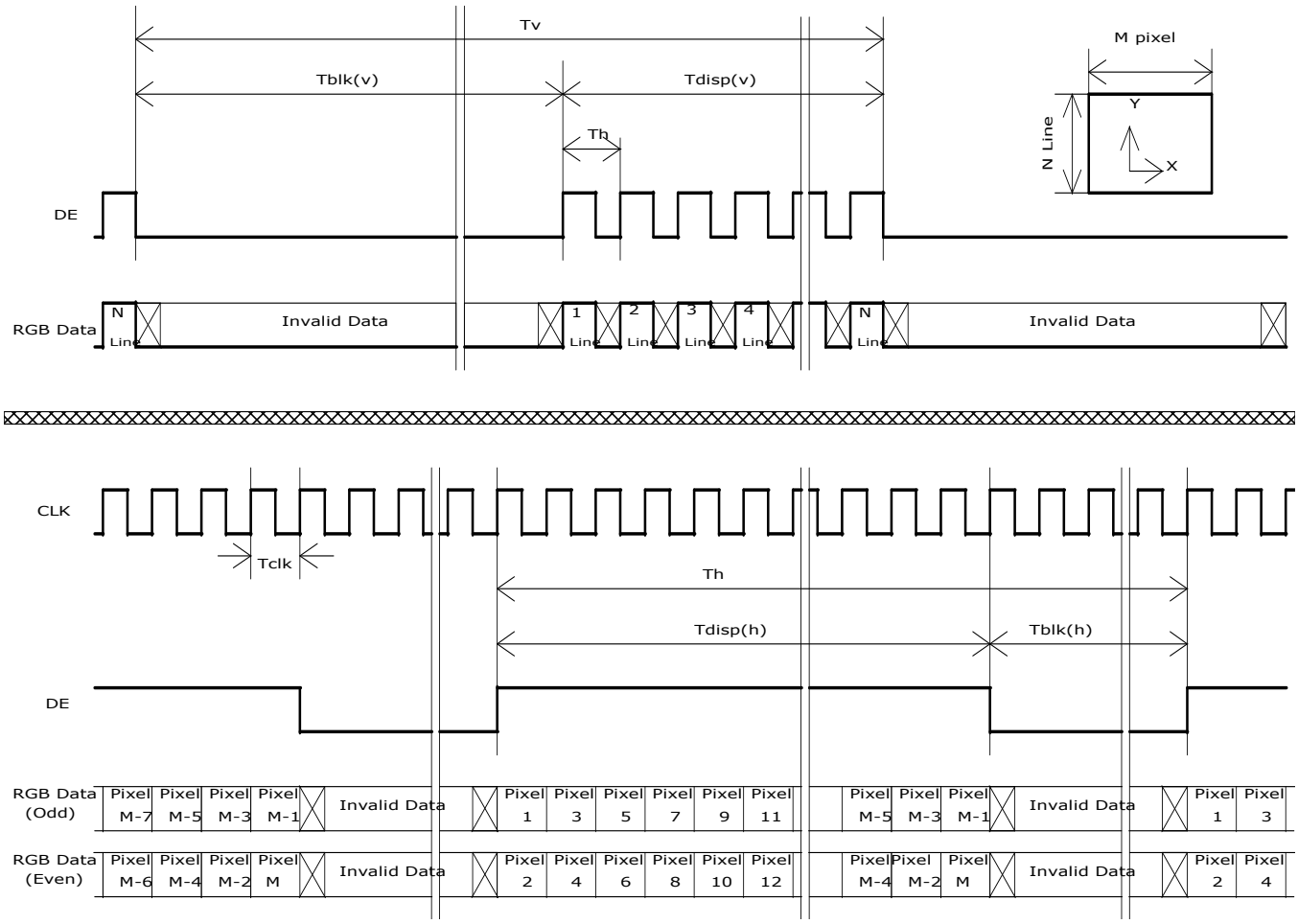
6.3.1 Timing Characteristics

For normal display, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock frequency		1/ T_{Clock}	67	69.3	76.3	MHz
Vertical Section	Period	T_V	778	793	768+A	T_{Line}
	Active	T_{VD}	768			
	Blanking	T_{VB}	20	25	A	
Horizontal Section	Period	T_H	1416	1456	1366+B	T_{Clock}
	Active	T_{HD}	1366			
	Blanking	T_{HB}	50	90	B	

Note 1 : The above is as optimized setting
Note 2 : The maximum clock frequency = (1366+B)*(768+A)*60<76.3MHz

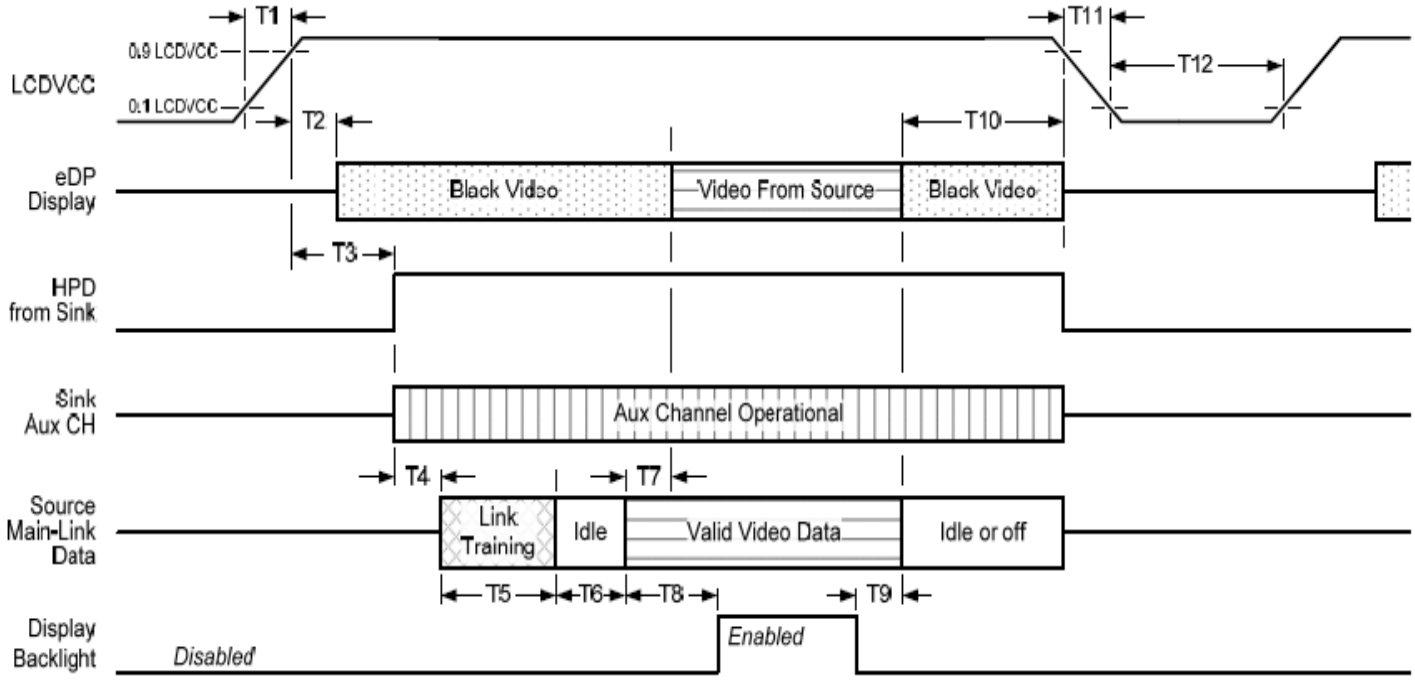
6.3.2 Timing diagram



6.4 Power ON/OFF Sequence

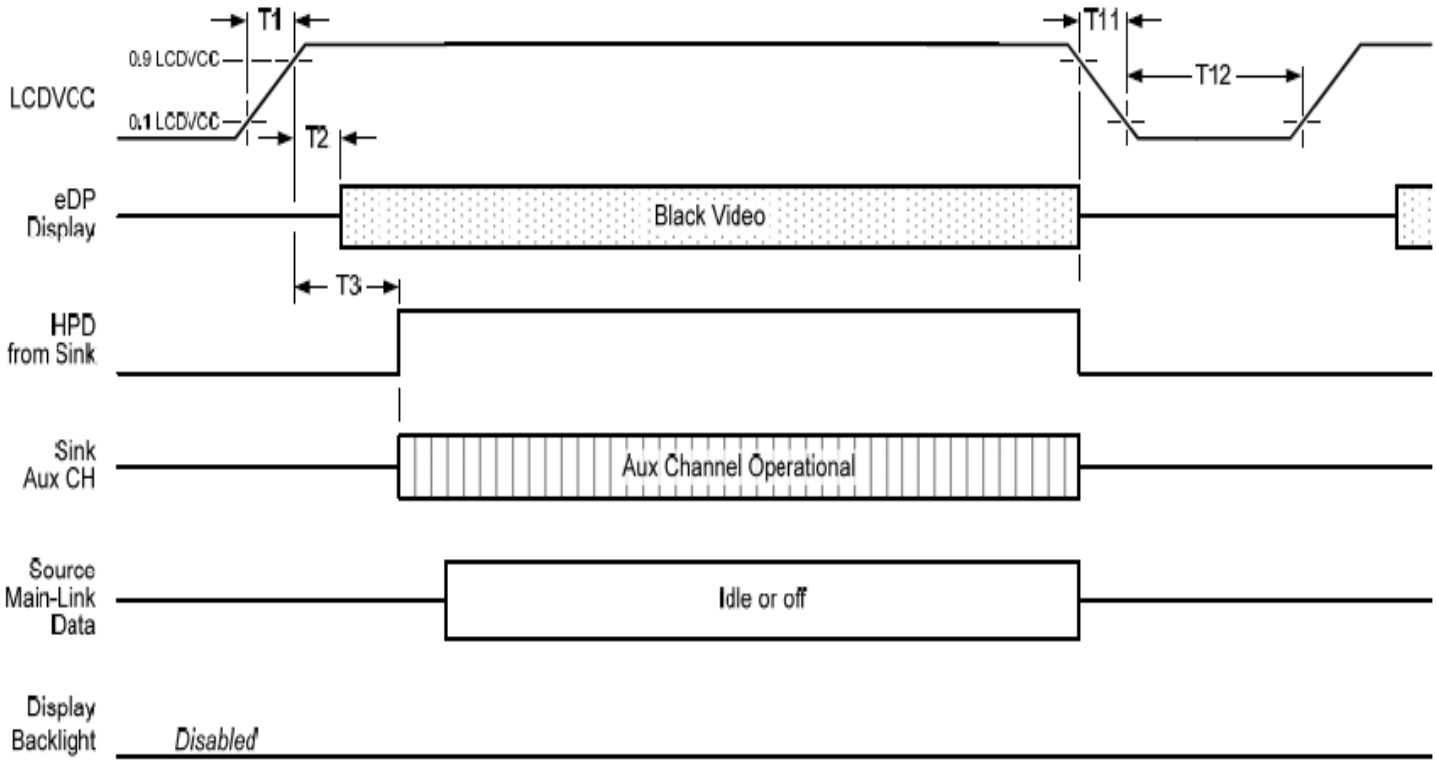
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only

Display Port panel power sequence timing parameter:

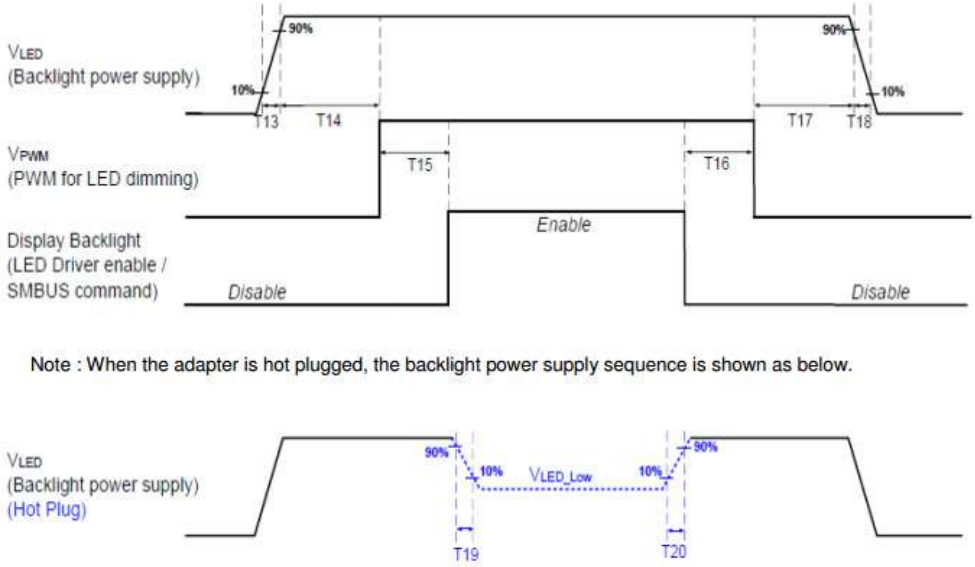
Timing parameter	Description	Reqd. by	Limits			Notes
			Min.	Typ.	Max.	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
T2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
T3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
T5	link training duration	source				dependant on source link to read training protocol.
T6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
T7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
T8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
T9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 905 to 10%	source			10ms	
T12	power off time	source	500ms			

Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:
-upon LCDVDD power on (with in T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).
-when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.

Display Port panel B/L power sequence timing parameter:



	Min (ms)	Max (ms)
T13	0.5	10
T14	10	-
T15	0	-
T16	0	-
T17	10	-
T18	0.5	10
T19	1*	-
T20	1*	-

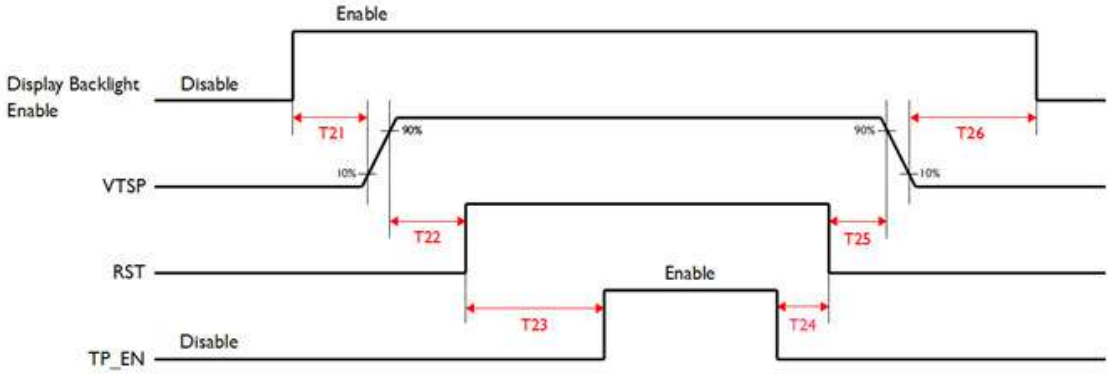
Seamless change: T19/T20 = 5xT_{PWM}*

*T_{PWM}= 1/PWM Frequency

Note : When the adapter is hot plugged, the backlight power supply sequence is shown as below.

Touch Panel Power on Sequence

I2C



	Min	Max
T21	10ms	-
T22	1ms	-
T23	20ms	-
T24	2ms	-
T25	2ms	-
T26	100ms	-

7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 240h	
High Temperature Operation	Ta= 50℃, Dry, 240h	
Low Temperature Operation	Ta=0℃, 240h	
High Temperature Storage	Ta= 60℃, 240h	
Low Temperature Storage	Ta= -20℃, 240h	
Thermal Shock Test	Ta=-20℃(30min) ~60℃(30min), 20cycles condition.	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

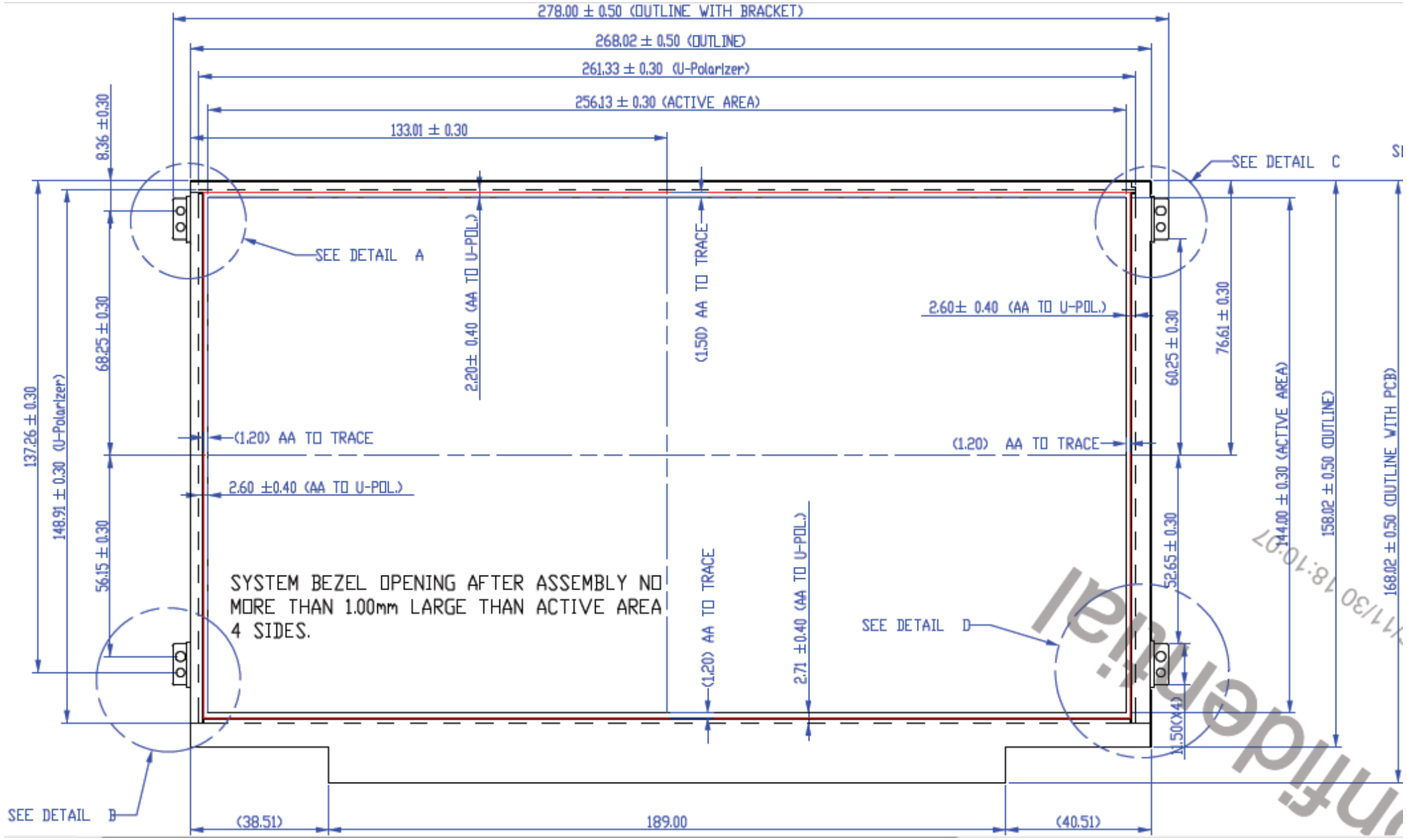
Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. No data lost

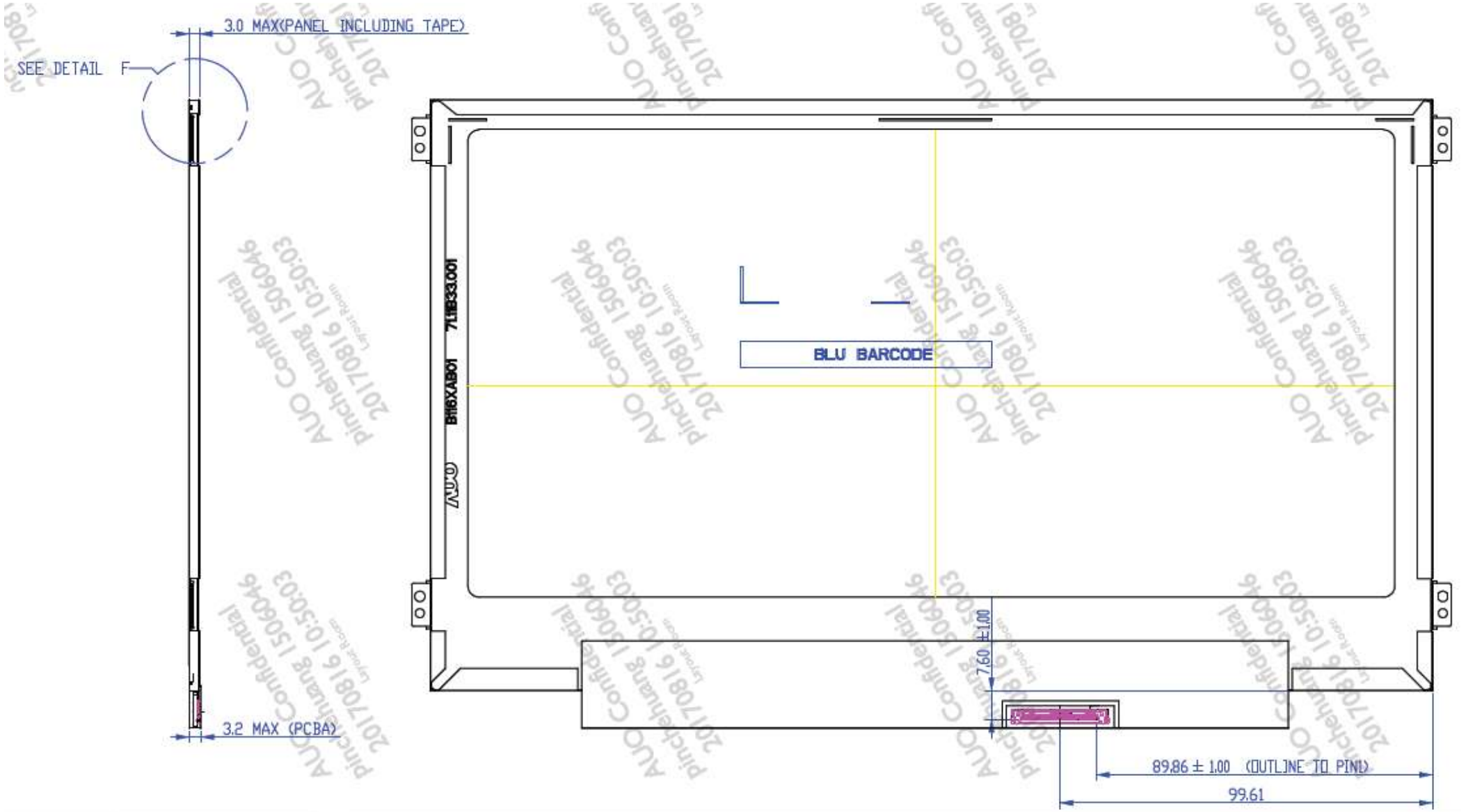
. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

8. Mechanical Characteristics

8.1 Total Solution Outline Dimension

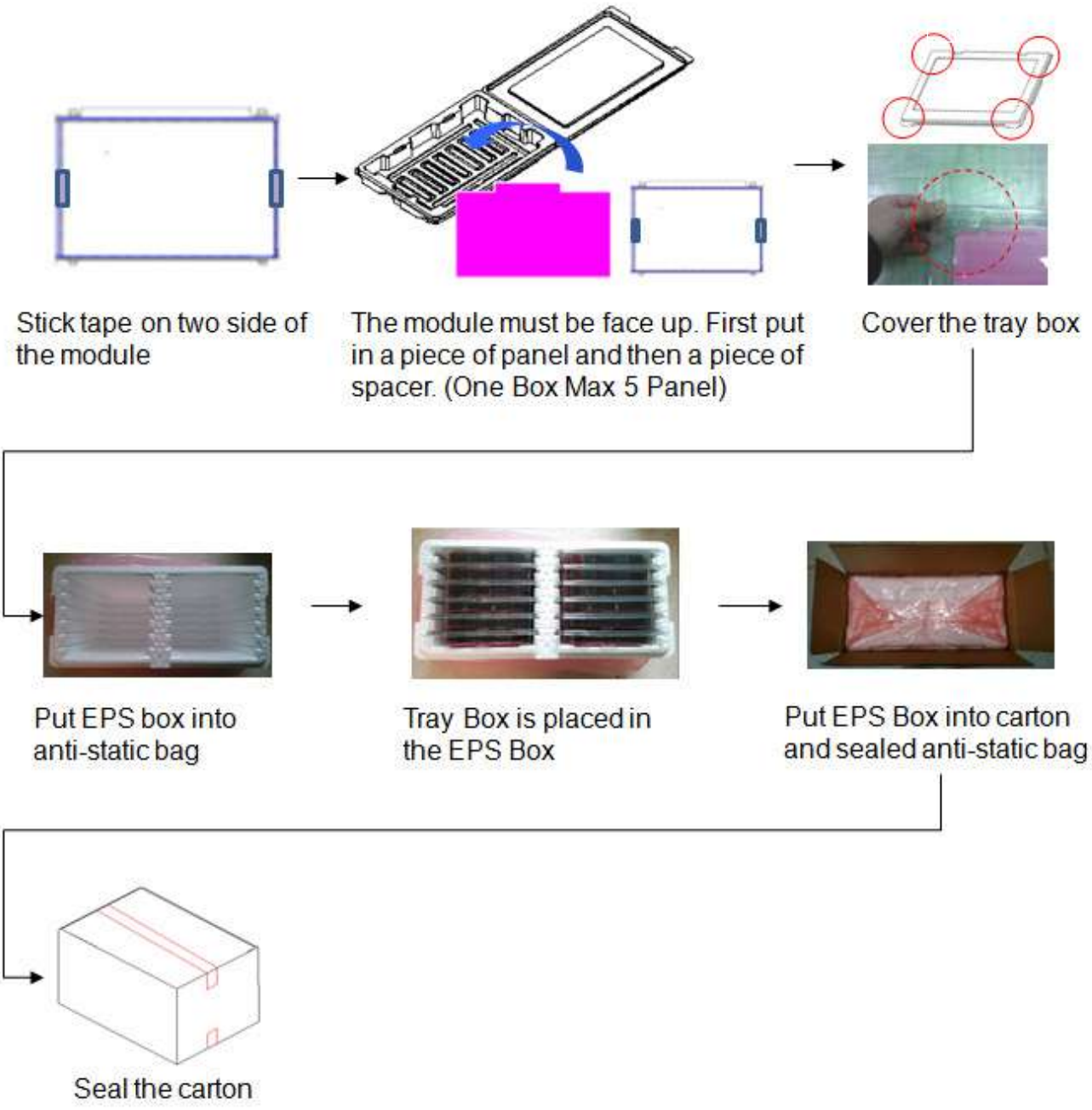



3.0 MAX(PANEL INCLUDING TAPE)
SEE DETAIL F
3.2 MAX (PCBA)
B116XAK01 711B33.001
BLU BARCODE
7.60 ± 1.00
89.86 ± 1.00 (OUTLINE TO PIN1)
99.61

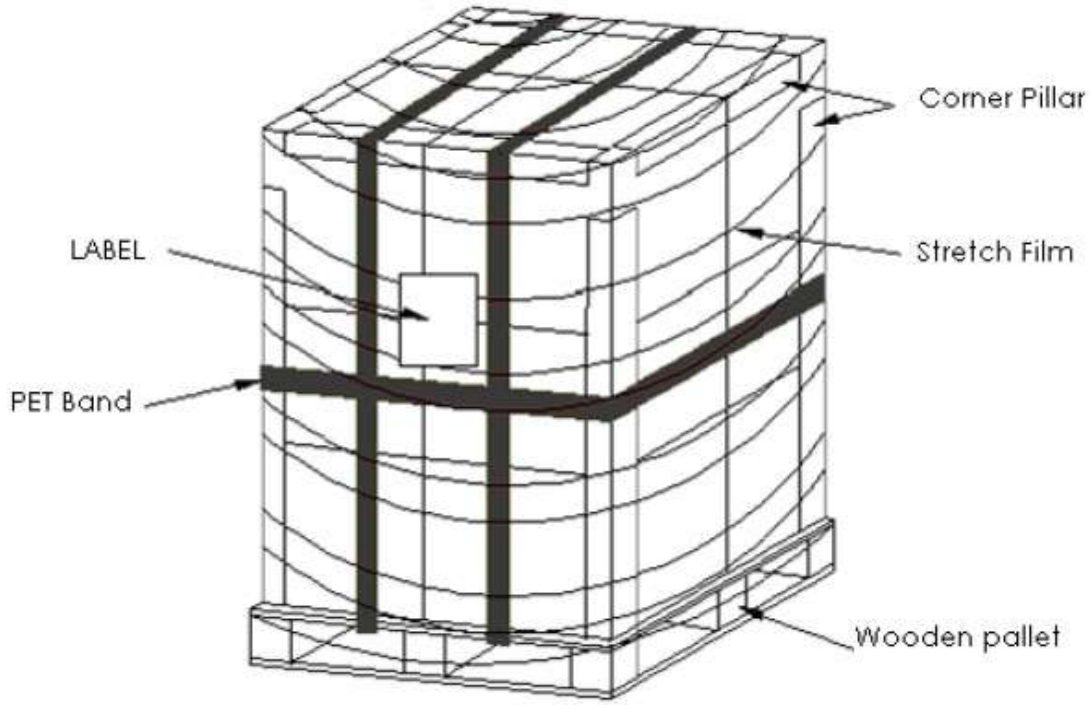
9. Shipping and Package

9.1 Shipping Label Format

9.2 Carton Package



9.3 Shipping Package of Palletizing Sequence



10. Appendix

10.1 EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	5C	01011100	92	
0B	hex, LSB first	40	01000000	64	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	1A	00011010	26	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	**Video input def. (digital I/P, non-TMDS, CRGB)**	95	10010101	149	
15	**Max H image size (rounded to cm)**	1A	00011010	26	
16	**Max V image size (rounded to cm)**	0E	00001110	14	
17	**Display Gamma (=(gamma*100)-100)**	78	01111000	120	
18	**Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)**	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	99	10011001	153	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	56	01010110	86	
1E	Green y	92	10010010	146	
1F	Blue x	28	00101000	40	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	

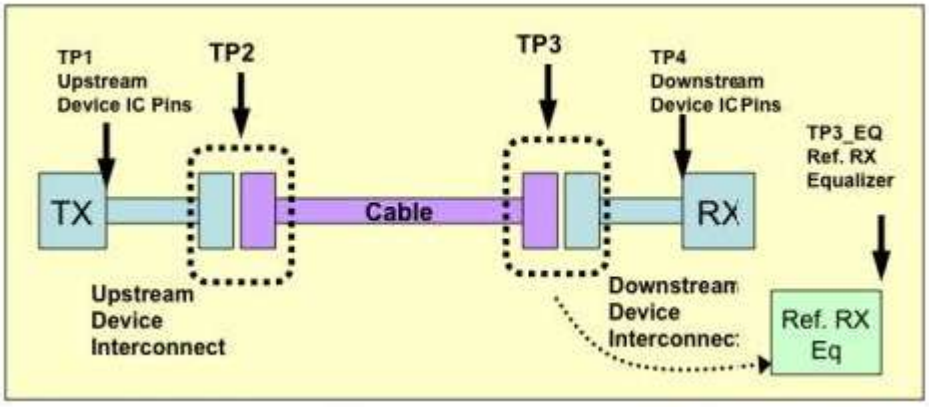
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	12	00010010	18	
37	Pixel Clock/10000 USB	1B	00011011	27	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	5A	01011010	90	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	19	00011001	25	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	20	00100000	32	
40	VertSync.Offset : VertSync.Width	46	01000110	70	
41	Horz&Vert Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	00	00000000	0	
43	Vertical Image Size Lower 8bits	90	10010000	144	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	

5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	A
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	O
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	B
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	31	00110001	49	1
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	58	01011000	88	X
76	Manufacture P/N	41	01000001	65	A
77	Manufacture P/N	4B	01001011	75	K
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	31	00110001	49	1
7A	Manufacture P/N	2E	00101110	46	.
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	CC	11001100	204	

10.2 Notes

DPCD Ver.	sDRRS	DCR	DMRRS	PSR	MBO	VESA DSC	MSO	Free-Sync	HDR	Dimming
1.1	No support	Off	No support	No support	No support	No support	No support	Off	No support	No support

1) The height of cell tape no higher than top polarizer 3.0mm
2) LED Driving Solution: Minimum change scale duty of the PWM is 0.1% @PWM frequency 200Hz.
3) When twisting or pressing LCD module, it may cause unexpected acoustic noises or sounds.
4) Maximum value of “Peak current” is as same as “Inrush current” in Electrical Characteristics (Power Specification)
5) VDiffP-P (Peak-to-peak Voltage at a receiving Device) follow as VESA display port standard (test point, TP3, is on panel’s PCBa)



6) Suggest ODMs do not use any parts that contain the ingredient of related Ammonium > 5ppb, and other ingredients, if any.
7) Suggest ODMs do not interfere with panel after system assembly in order to avoid possible mura, yellow spot, light leakage, water ripple or side defects by mechanical stress test.
8) For LCM display (thickness >= 2.6mm), the height of PCBa/FPC floating area 0.5mm max (compressible).
9) For total solution display (thickness >= 2.6mm), the height of PCBa/FPCa/FPC floating area 0.7mm max (compressible).